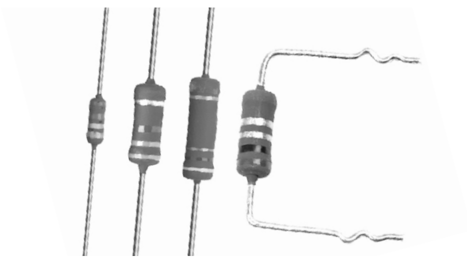
Power Metal Film Leaded Resistors



DESCRIPTION

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting wires of electrolytic copper or copper-clad iron are welded to the end-caps. The resistors are coated with a red, non-flammable lacquer which provides electrical, mechanical and climatic protection. This coating is not resistant to aggressive fluxes. The encapsulation is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

FEATURES

- High power in small packages (1 W/0207 size to 3 W/0617 size)
- Different lead materials for different applications
- Defined interruption behaviour
- Lead (Pb)-free solder contacts
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Compliant to RoHS directive 2002/95/EC

Pb-free
RoHS
COMPLIANT

APPLICATIONS

- All general purpose power applications

TECHNICAL SPECIFICATIONS

DESCRIPTION	VALUE				
	PR01	PR02		PR03	
		Cu-lead	FeCu-lead	Cu-lead	FeCu-lead
Resistance Range [2]	0.22 Ω to 1 MΩ	0.33 Ω to 1 MΩ	1 Ω to 1 MΩ	0.68 Ω to 1 MΩ	1 Ω to 1 MΩ
Resistance Tolerance and Series	± 1 % (E24, E96 series); ± 5 % (E24 series) [1]				
Rated Dissipation, P_{70}:					
$R < 1\ \Omega$	0.6 W	1.2 W	-	1.6 W	-
$1\ \Omega \leq R$	1 W	2 W	1.3 W	3 W	2.5 W
Thermal Resistance (R_{th})	135 K/W	75 K/W	115 K/W	60 K/W	75 K/W
Temperature Coefficient	≤ ± 250 ppm/K				
Maximum Permissible Voltage ($U_{max.}$ AC/DC)	350 V	500 V		750 V	
Basic Specifications	IEC 60115-1				
Climatic Category (IEC 60068-1)	55/155/56				
Stability After:					
Load (1000 h, P_{70})	ΔR max.: ± (5 % R + 0.1 Ω)				
Long Term Damp Heat Test (56 Days)	ΔR max.: ± (3 % R + 0.1 Ω)				
Soldering (10 s, 260 °C)	ΔR max.: ± (1 % R + 0.05 Ω)				

Notes

(1) 1 % tolerance is available for R_n-range from 1 R upwards
(2) Ohmic values (other than resistance range) are available on request
- R value is measured with probe distance of 24 mm ± 1 mm using 4-terminal method

For technical questions, contact: filmresistorsleaded@vishay.com
Document Number: 28729
Revision: 14-Oct-09

PART NUMBER AND PRODUCT DESCRIPTION

PART NUMBER: PR02000201001JA100

P	R	0	2	0	0	0	2	0	1	0	0	1	J	A	1	0	0

MODEL/SIZE	VARIANT	WIRE TYPES	TCR/MATERIAL	VALUE	TOLERANCE	PACKAGING (1)	SPECIAL
PR0100 **PR0200** **PR0300**	**0** = Neutral **Z** = Value overflow (Special)	**1** = Cu 0.6 **2** = Cu 0.8 **3** = FeCu 0.6 **4** = FeCu 0.8	**0** = Standard	**3 digit value** **1 digit multiplier** MULTIPLIER **7** = $*10^{-3}$ **2** = $*10^{2}$ **8** = $*10^{-2}$ **3** = $*10^{3}$ **9** = $*10^{-1}$ **4** = $*10^{4}$ **0** = $*10^{0}$ **5** = $*10^{5}$ **1** = $*10^{1}$	**F** = ± 1 % **J** = ± 5 %	**N4** **R2** **N3** **L1** **A5** **DC** **A1** **K1** **AC** **B1** **R5** **PC**	The 2 digits are used for all special parts. **00** = Standard

PRODUCT DESCRIPTION: PR02 5 % A1 1K0

PR02	5 %	A1	1K0
MODEL/SIZE	TOLERANCE	PACKAGING (1)	RESISTANCE VALUE
PR01 **PR02** **PR03**	± 1 % ± 5 %	**N4** **L1** **N3** **DC** **A5** **K1** **A1** **B1** **AC** **PC** **R5** **R2**	**1K0** = 1 kΩ **4K75** = 4.75 kΩ

Notes

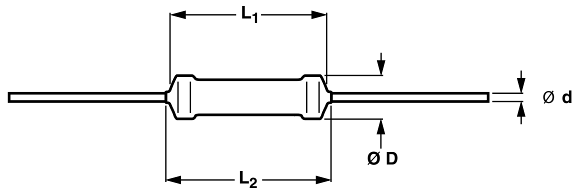
(1) Please refer to table PACKAGING for details

- The PART NUMBER is shown to facilitate the introduction of a unified part numbering system for ordering products

PACKAGING

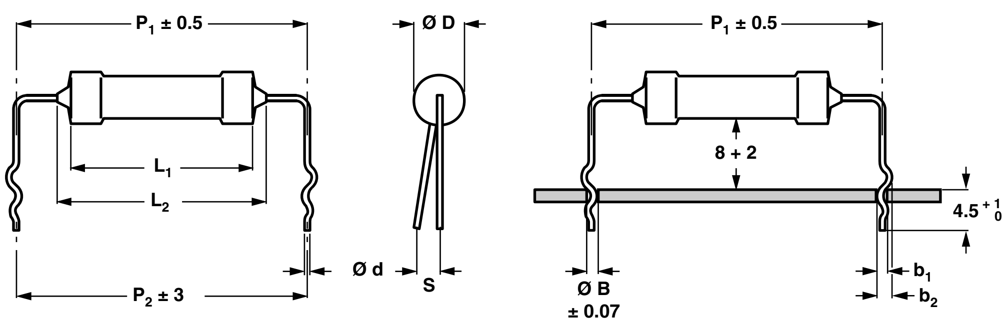
MODEL	TAPING	AMMO PACK		REEL		BULK, DOUBLE KINK		
		PIECES	CODE	PIECES	CODE	PITCH	PIECES	CODE
PR01	Axial, 52 mm	5000	A5	5000	R5			
		1000	A1					
	Radial	4000	N4			17.8 mm	1000	L1
						12.5 mm	1000	K1
PR02	Axial, 52 mm	1000	A1	5000	R5			
	Radial	3000	N3	2000	R2	17.8 mm	1000	L1
						15.0 mm	1000	B1
PR03	Axial, 63 mm	500	AC					
	Radial					25.4 mm	500	DC
						20.0 mm	500	PC

DIMENSIONS



Type with straight leads

DIMENSIONS - Straight lead type and relevant physical dimensions; see straight leads outline					
TYPE	**Ø $D_{max.}$ (mm)**	**$L_{1\ max.}$ (mm)**	**$L_{2\ max.}$ (mm)**	**Ø d (mm)**	
				Cu	**FeCu**
PR01	2.5	6.5	8.0	0.58 ± 0.05	-
PR02	3.9	10.0	12.0	0.78 ± 0.05	0.58 ± 0.05
PR03	5.2	16.7	19.5	0.78 ± 0.05	0.58 ± 0.05

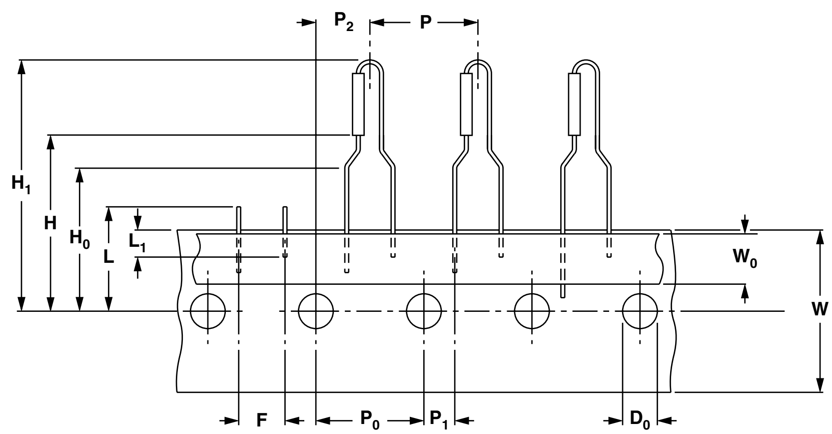


Type with double kink

Dimensions in millimeters

DIMENSIONS - Double kink lead type and relevant physical dimensions; see double kinked outline										
TYPE	**LEAD STYLE**	**Ø d (mm)**		**b_1 (mm)**	**b_2 (mm)**	**Ø $D_{max.}$ (mm)**	**P_1 (mm)**	**P_2 (mm)**	**$S_{max.}$ (mm)**	**Ø B (mm)**
		Cu	**FeCu**							
PR01	Double kink large pitch	0.58 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20	2.5	17.8	17.8	2	0.8
	Double kink small pitch	-	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20		12.5	12.5	2	0.8
PR02	Double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.45 + 0.25/- 0.20	3.9	17.8	17.8	2	0.8
	Double kink small pitch	-	0.78 ± 0.05	1.30 + 0.25/- 0.20	1.65 + 0.25/- 0.20		15.0	15.0	2	1.0
PR03	Double kink large pitch	0.78 ± 0.05	0.58 ± 0.05	1.10 + 0.25/- 0.20	1.65 + 0.25/- 0.20	5.2	25.4	25.4	2	1.0
	Double kink small pitch	-	0.78 ± 0.05	1.30 + 0.25/- 0.20	2.15 + 0.25/- 0.20		22.0	20.0	2	1.0

PRODUCTS WITH RADIAL LEADS (PR01, PR02)



DIMENSIONS - RADIAL TAPING				
SYMBOL	PARAMETER	VALUE	TOLERANCE	UNIT
P	Pitch of components	12.7	± 1.0	mm
P_0	Feed-hole pitch	12.7	± 0.2	mm
P_1	Feed-hole centre to lead at topside at the tape	3.85	± 0.5	mm
P_2	Feed-hole center to body center	6.35	± 1.0	mm
F	Lead-to-lead distance	4.8	+ 0.7/- 0	mm
W	Tape width	18.0	± 0.5	mm
W_0	Minimum hold down tape width	5.5	-	mm
H_1	Component height PR01	29	Max.	mm
	Component height PR02	29	± 3.0	
H_0	Lead wire clinch height	16.5	± 0.5	mm
H	Height of component from tape center	19.5	± 1	mm
D_0	Feed-hole diameter	4.0	± 0.2	mm
L	Maximum length of snipped lead	11.0	-	mm
L_1	Minimum lead wire (tape portion) shortest lead	2.5	-	mm

Note
- Please refer document number 28721 “Packaging” for more detail

MASS PER UNIT

TYPE	MASS (mg)
PR01 Cu 0.6 mm	212
PR01 FeCu 0.6 mm	207
PR02 Cu 0.8 mm	504
PR02 FeCu 0.6 mm	455
PR02 FeCu 0.8 mm	496
PR03 Cu 0.8 mm	1192
PR03 FeCu 0.6 mm	1079
PR03 FeCu 0.8 mm	1185

MARKING

The nominal resistance and tolerance are marked on the resistor using four or five colored bands in accordance with IEC 60062, marking codes for resistors and capacitors.

OUTLINES

The length of the body (L_1) is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation (IEC 60294).

MOUNTING

The resistors are suitable for processing on automatic insertion equipment and cutting and bending machines.

MOUNTING PITCH

TYPE	LEAD STYLE	PITCH	
		mm	e
PR01	Straight leads	12.5 (1)	5 (1)
	Radial taped	4.8	2
	Double kink large pitch	17.8	7
	Double kink small pitch	12.5	5
PR02	Straight leads	15.0 (1)	6 (1)
	Radial taped	4.8	2
	Double kink large pitch	17.8	7
	Double kink small pitch	15.0	6
PR03	Straight leads	23.0 (1)	9 (1)
	Double kink large pitch	25.4	10
	Double kink small pitch	20.0	8

Note

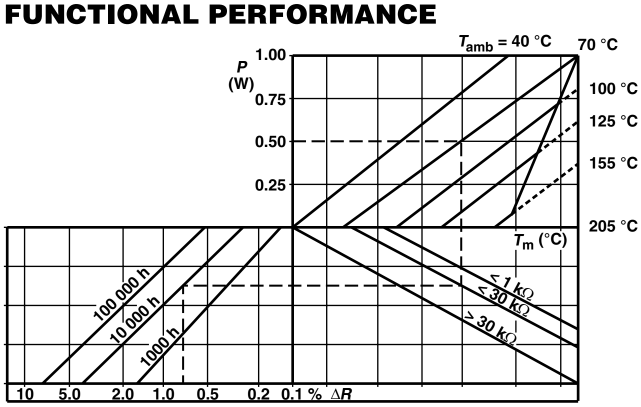
(1) Recommended minimum value

FUNCTIONAL DESCRIPTION

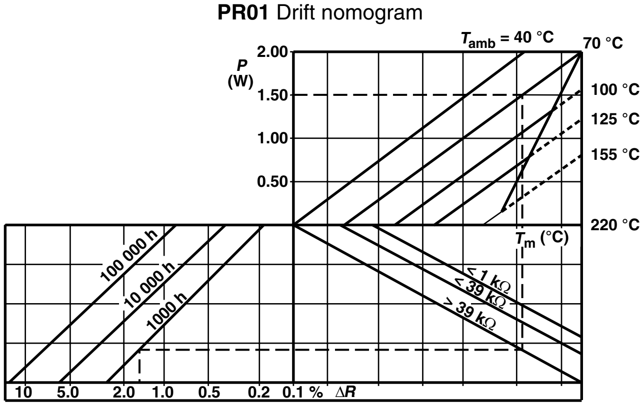
PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E96/E24 series for resistors with a tolerance of ± 1 % or ± 5 %. The values of the E96/E24 series are in accordance with IEC 60063.

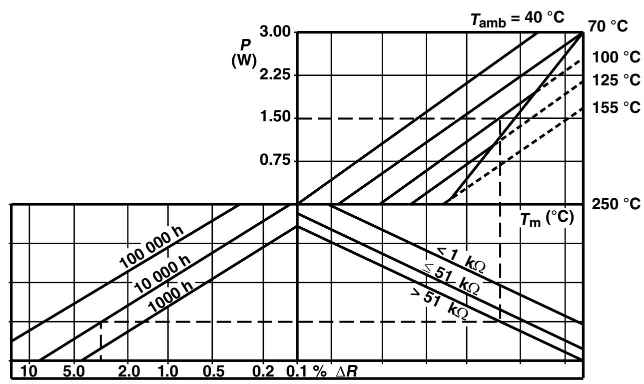
FUNCTIONAL PERFORMANCE



PR01 Drift nomogram



PR02 Drift nomogram

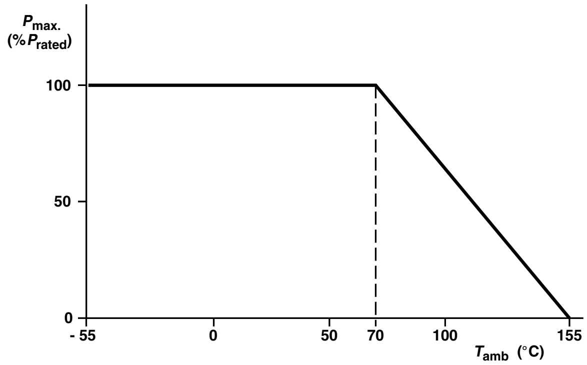


PR03 Drift nomogram

Note

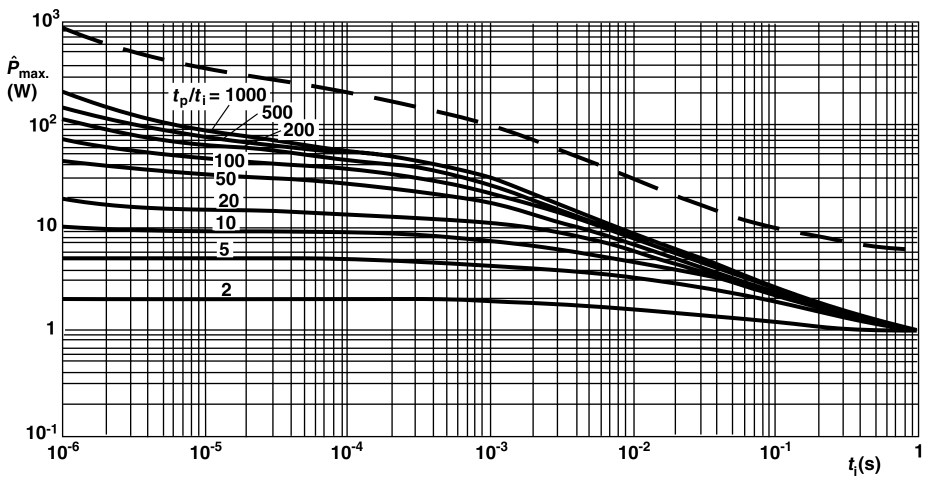
- The maximum permissible hot-spot temperature is 205 °C for PR01, 220 °C for PR02 and 250 °C for PR03

The power that the resistor can dissipate depends on the operating temperature.

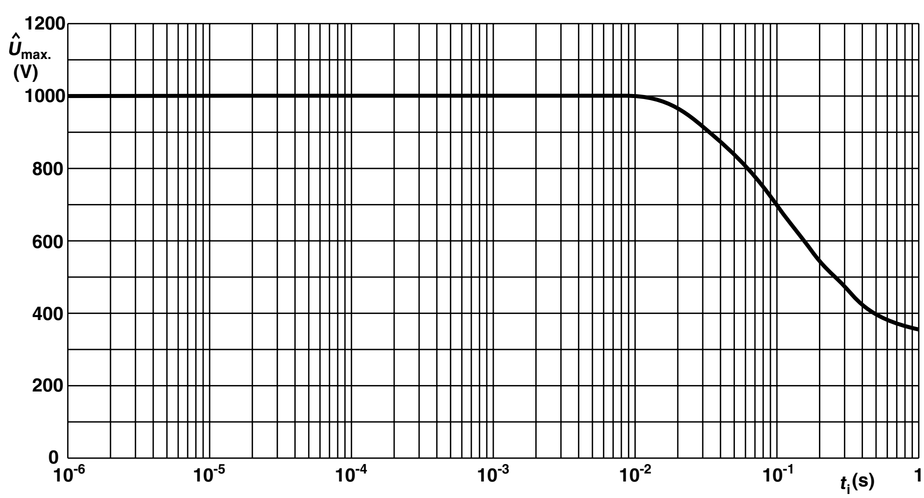


Maximum dissipation ($P_{max.}$) in percentage of rated power as a function of the ambient temperature (T_{amb})

Derating

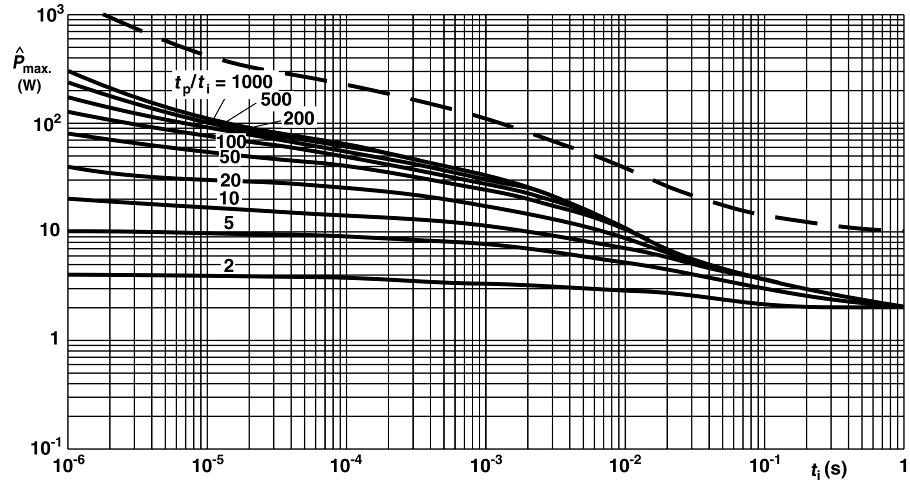


PR01 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max.}$) as a function of pulse duration (t_i)

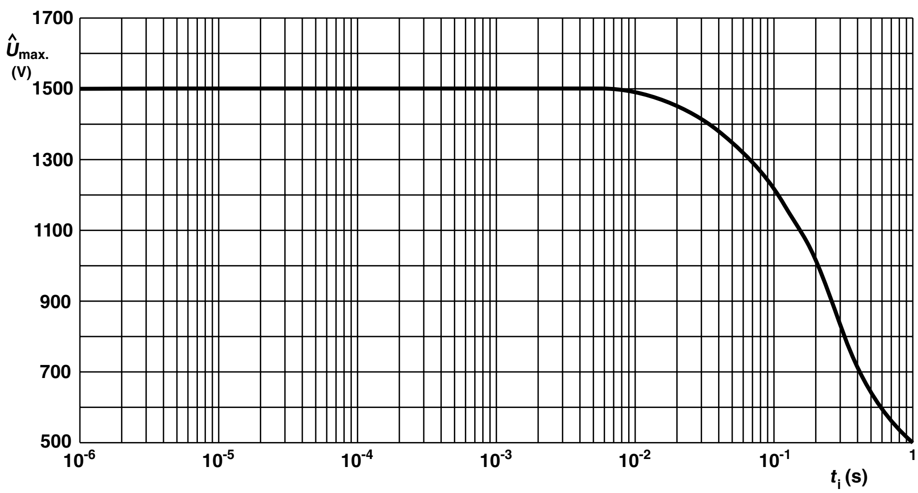


PR01 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{U}_{max.}$) as a function of pulse duration (t_i)

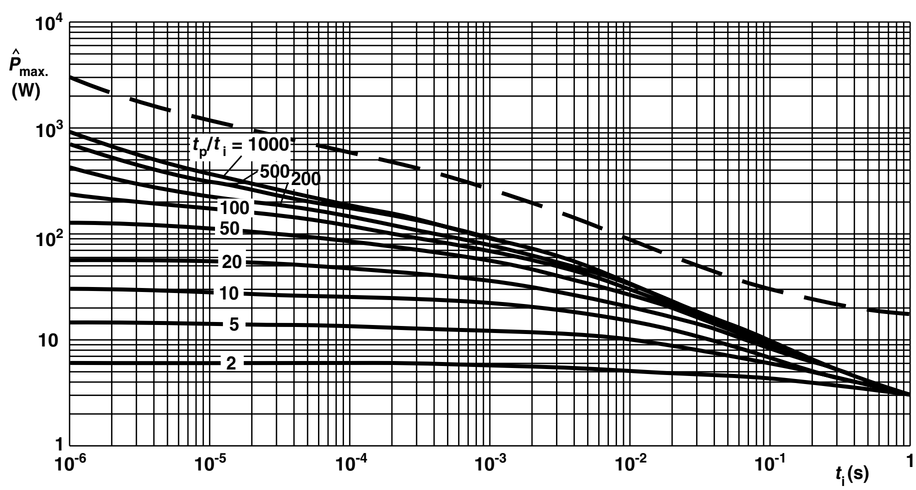
Pulse Loading Capabilities



PR02 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max.}$) as a function of pulse duration (t_i)

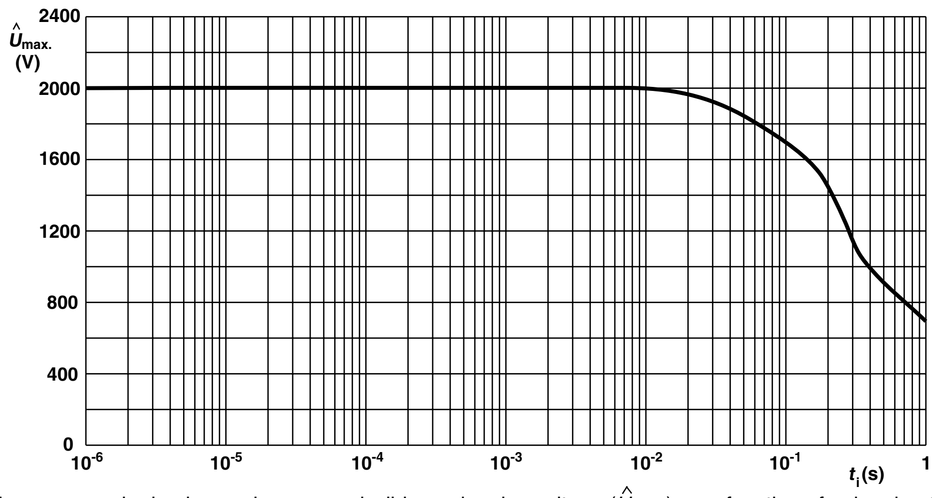


PR02 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{U}_{max.}$) as a function of pulse duration (t_i)



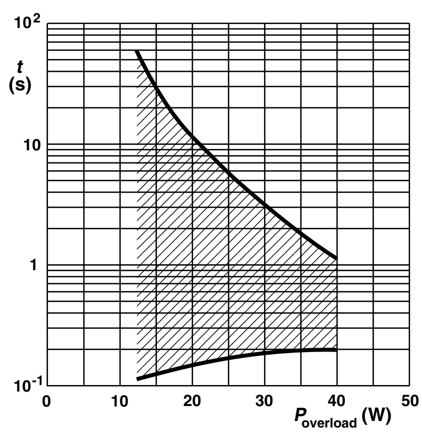
PR03 Pulse on a regular basis; maximum permissible peak pulse power ($\hat{P}_{max.}$) as a function of pulse duration (t_i)

Pulse Loading Capabilities

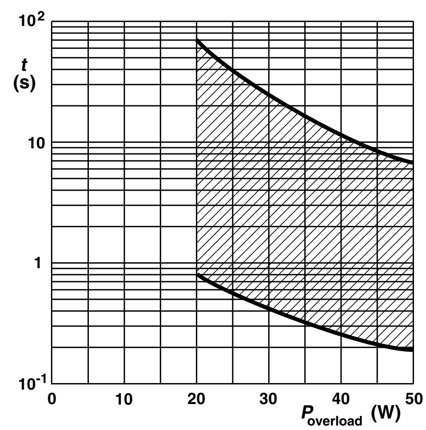


PR03 Pulse on a regular basis; maximum permissible peak pulse voltage ($\hat{U}_{max.}$) as a function of pulse duration (t_i)

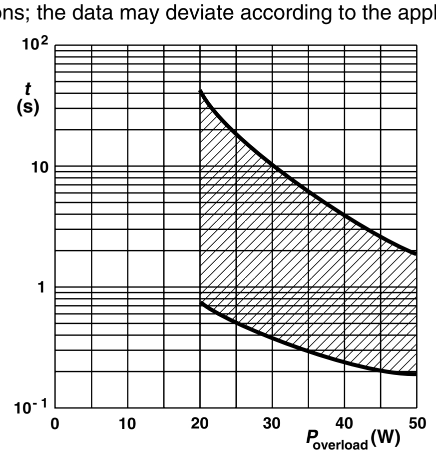
Pulse Loading Capabilities



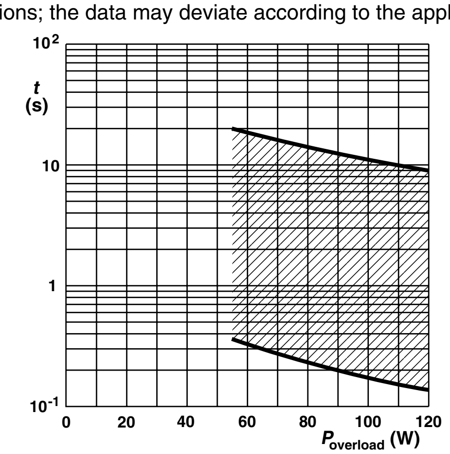
PR01 Time to interruption as a function of overload power
for range: $0\ R\ 22 \le R_n < 1\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



PR01 Time to interruption as a function of overload power
for range: $16\ R \le R_n \le 560\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

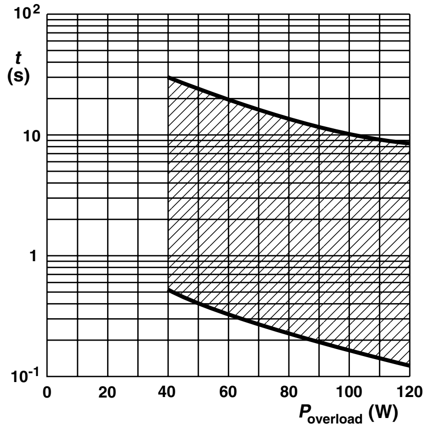


PR01 Time to interruption as a function of overload power
for range: $1\ R \le R_n \le 15\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

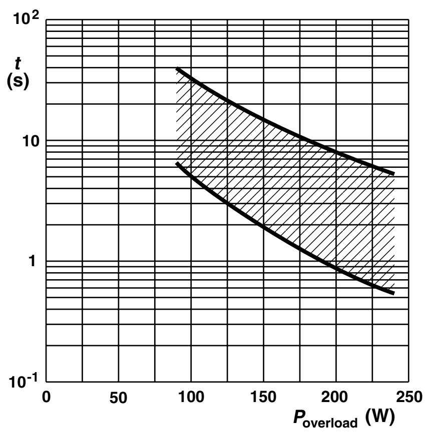


PR02 Time to interruption as a function of overload power
for range: $0.33\ R \le R_n < 5\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

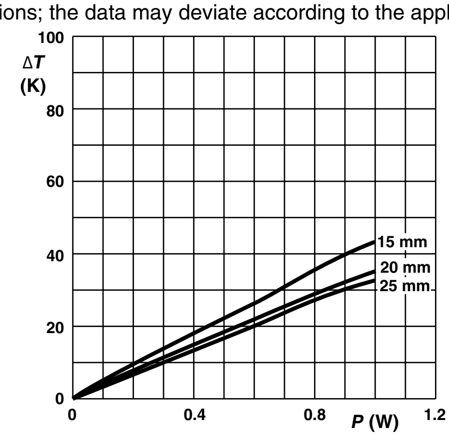
Interruption Characteristics



PR02 Time to interruption as a function of overload power
for range: 5 $R \leq R_n < 68\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



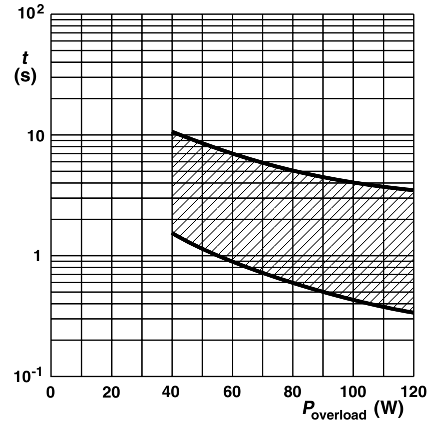
PR03 Time to interruption as a function of overload power
for range: 0.68 $R \leq R_n \leq 560\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.



Ø 0.6 mm Cu-leads
Minimum distance from resistor body to PCB = 1 mm

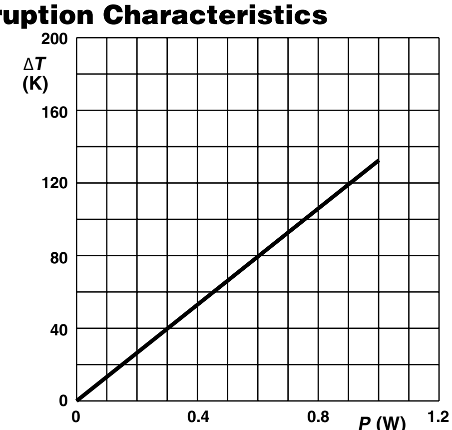
PR01 Temperature rise (Δ*T*) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

Application Information



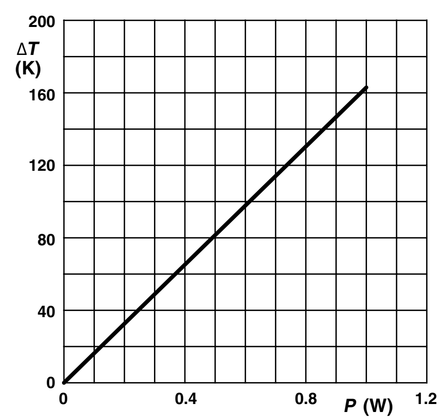
PR02 Time to interruption as a function of overload power
for range: 68 $R \leq R_n \leq 560\ R$
This graph is based on measured data under constant voltage conditions; the data may deviate according to the applications.

Interruption Characteristics



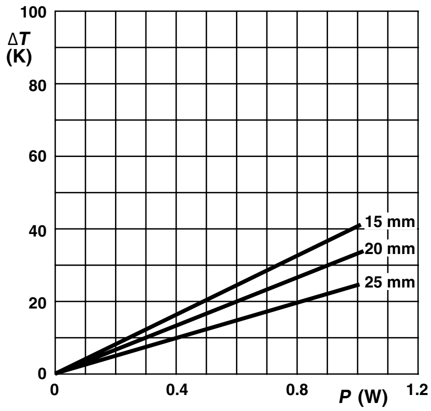
Ø 0.6 mm Cu-leads

PR01 Hot-spot temperature rise (Δ*T*) as a function of dissipated power.



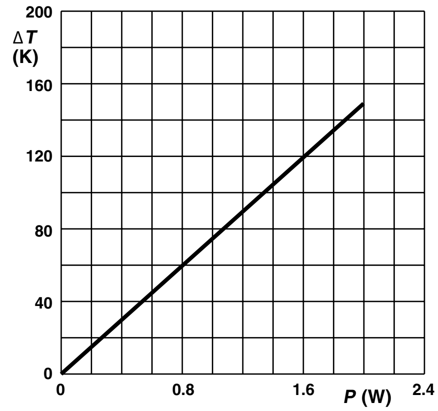
Ø 0.6 mm FeCu-leads

PR01 Hot-spot temperature rise (Δ*T*) as a function of dissipated power.



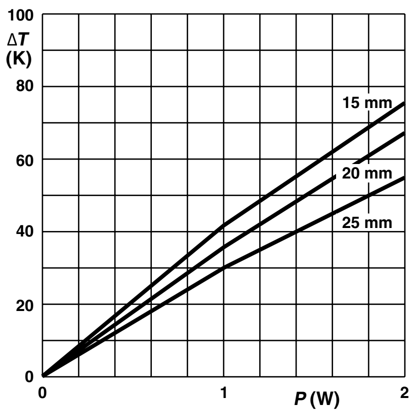
Ø 0.6 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

PR01 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



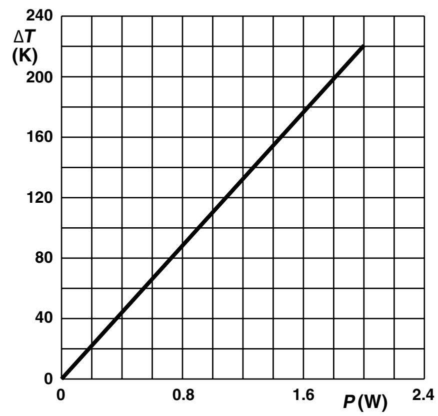
Ø 0.8 mm Cu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



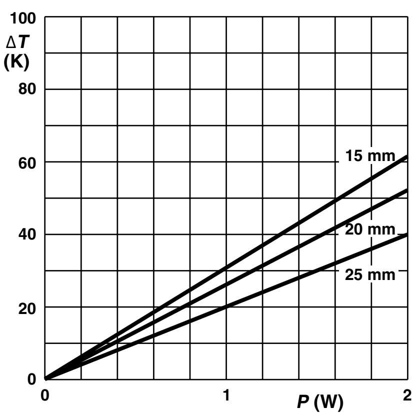
Ø 0.8 mm Cu-leads
Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



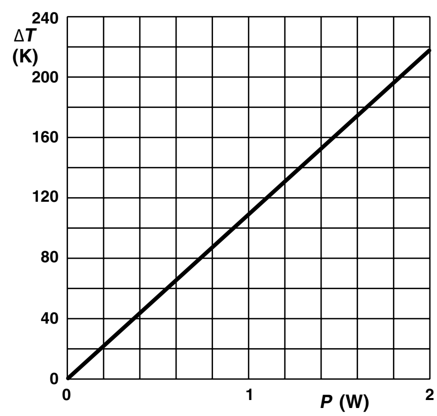
Ø 0.6 mm FeCu-leads

PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.



Ø 0.6 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

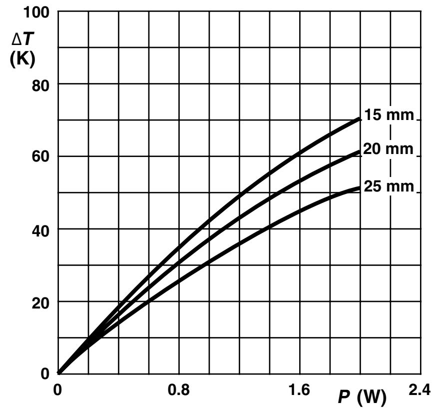
PR02 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.8 mm FeCu-leads

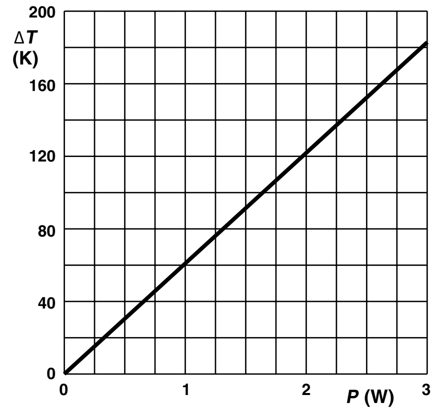
PR02 Hot-spot temperature rise (ΔT) as a function of dissipated power.

Application Information



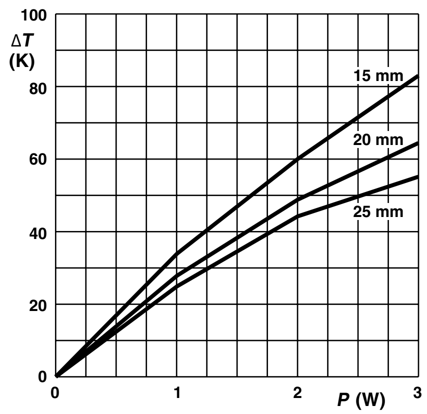
Ø 0.8 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

PR02 Temperature rise (Δ*T*) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



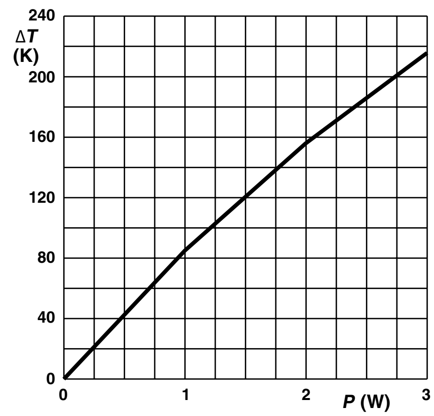
Ø 0.8 mm Cu-leads

PR03 Hot-spot temperature rise (Δ*T*) as a function of dissipated power.



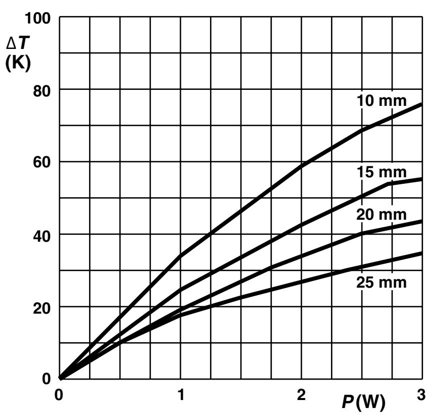
Ø 0.8 mm Cu-leads
Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (Δ*T*) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



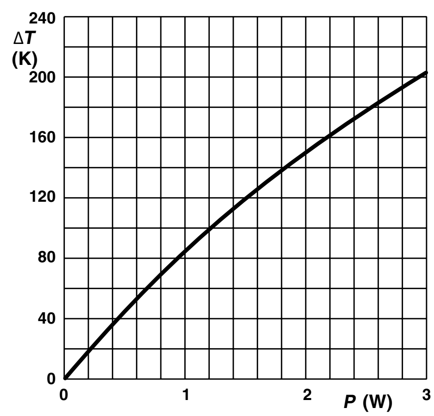
Ø 0.6 mm FeCu-leads

PR03 Hot-spot temperature rise (Δ*T*) as a function of dissipated power.



Ø 0.6 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

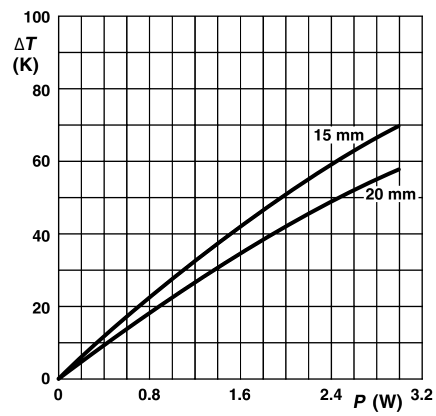
PR03 Temperature rise (Δ*T*) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.



Ø 0.8 mm FeCu-leads

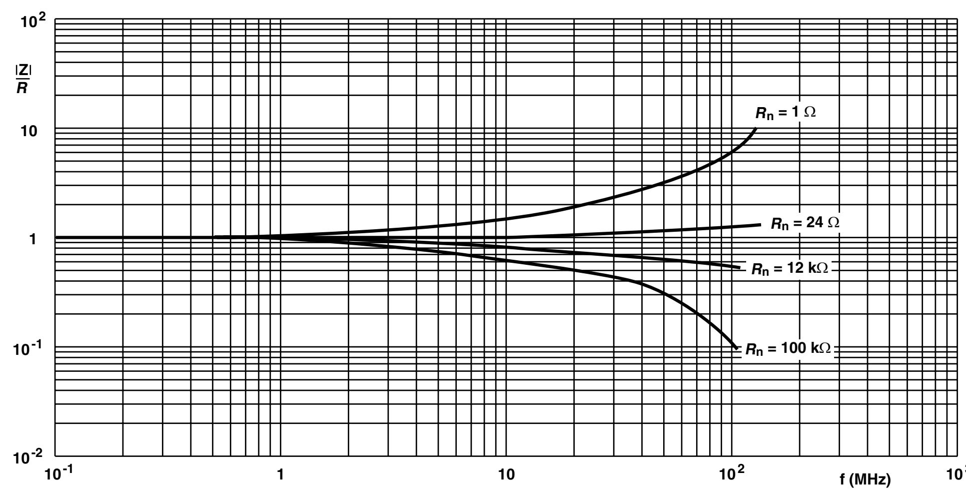
PR03 Hot-spot temperature rise (Δ*T*) as a function of dissipated power.

Application Information

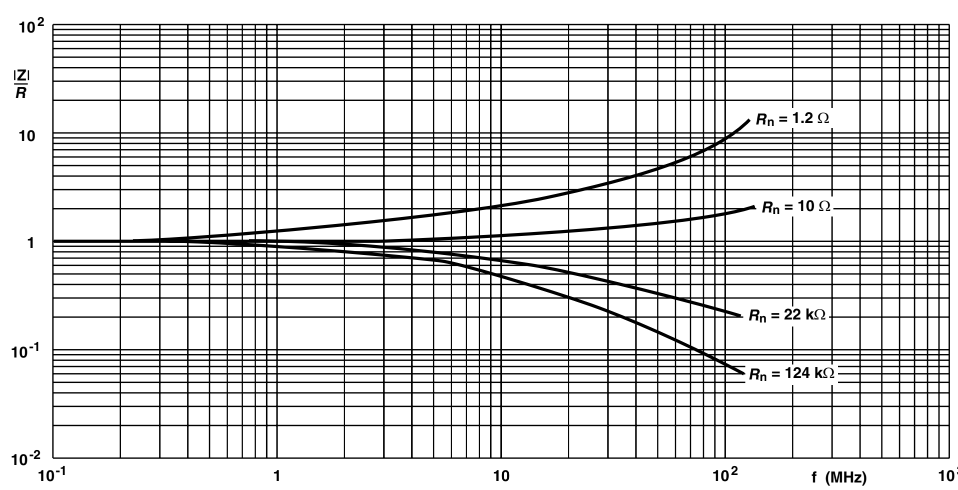


Ø 0.8 mm FeCu-leads
Minimum distance from resistor body to PCB = 1 mm

PR03 Temperature rise (ΔT) at the lead end (soldering point) as a function of dissipated power at various lead lengths after mounting.

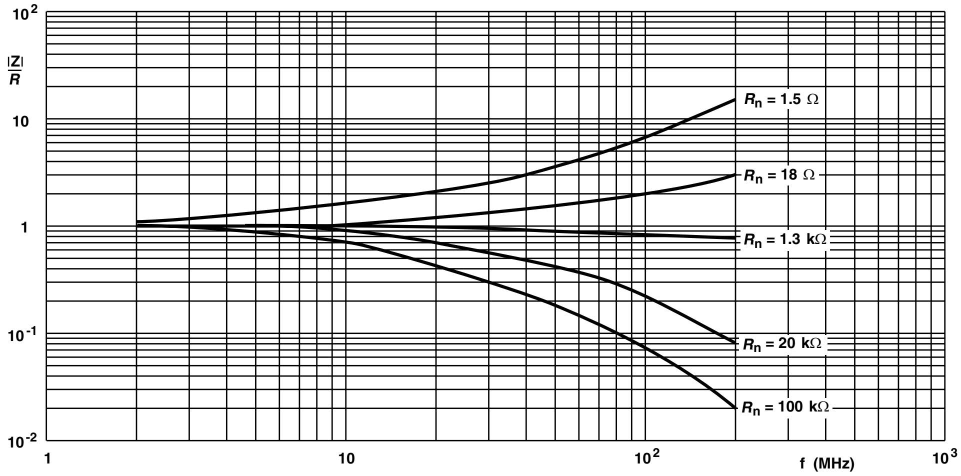


PR01 Impedance as a function of applied frequency



PR02 Impedance as a function of applied frequency

Application Information



PR03 Impedance as a function of applied frequency

Application Information

TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with IEC 60115-1 specification, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category Temperature; damp heat, long term, 56 days).

The tests are carried out in accordance with IEC 60068-2-xx Test Method under standard atmospheric conditions according to IEC 60068-1, 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying.

All soldering tests are performed with mildly activated flux.

TEST PROCEDURES AND REQUIREMENTS

IEC 60115-1 CLAUSE	IEC 60068-2-TEST METHOD	TEST	PROCEDURE	REQUIREMENTS
4.4.1		Visual examination		No holes; clean surface; no damage
4.4.2		Dimensions (outline)	Gauge (mm)	See Straight and Kinked Dimensions tables
4.5		Resistance (refer note on first page for measuring distance)	Applied voltage (+ 0 %/- 10 %): R < 10 Ω: 0.1 V 10 Ω ≤ R < 100 Ω: 0.3 V 100 Ω ≤ R < 1 kΩ: 1 V 1 kΩ ≤ R < 10 kΩ: 3 V 10 kΩ ≤ R < 100 kΩ: 10 V 100 kΩ ≤ R < 1 MΩ: 25 V R = 1 MΩ: 50 V	$R - R_{nom}$: max. ± 5 %
4.18	20 (Tb)	Resistance to soldering heat	Thermal shock: 10 s; 260 °C; 3 mm from body	ΔR max.: ± (1 % R + 0.05 Ω)
4.29	45 (Xa)	Component solvent resistance	Isopropyl alcohol or H_2O followed by brushing	No visual damage

TEST PROCEDURES AND REQUIREMENTS				
IEC 60115-1 CLAUSE	**IEC 60068-2-TEST METHOD**	**TEST**	**PROCEDURE**	**REQUIREMENTS**
4.17	20 (Ta)	Solderability	2 s; 235 °C; Solder bath method; SnPb40 3 s; 245 °C; Solder bath method; SnAg3Cu0.5	Good tinning (≥ 95 % covered); no damage
		Solderability (after ageing)	8 h steam or 16 h 155 °C; leads immersed 6 mm: for 2 s at 235 °C; solder bath (SnPb40) for 3 s at 245 °C; solder bath (SnAg3Cu0.5)	Good tinning (≥ 95 % covered); no damage
4.7		Voltage proof on insulation	Maximum voltage U_{RMS} = 500 V during 1 min; metal block method	No breakdown or flashover
4.16		Robustness of terminations:		
4.16.2	21 (Ua1)	Tensile all samples	Load 10 N; 10 s	Number of failures: < 1 x 10^{-6}
4.16.3	21 (Ub)	Bending half number of samples	Load 5 N; 4 x 90°	Number of failures: < 1 x 10^{-6}
4.16.4	21 (Uc)	Torsion other half of samples	3 x 360° in opposite directions	No damage Δ*R* max.: ± (0.5 % *R* + 0.05 Ω)
4.20	29 (Eb)	Bump	3 x 1500 bumps in three directions; 40 g	No damage Δ*R* max.: ± (0.5 % *R* + 0.05 Ω)
4.22	6 (Fc)	Vibration	Frequency 10 Hz to 500 Hz; displacement 1.5 mm or acceleration 10 g; three directions; total 6 h (3 x 2 h)	No damage Δ*R* max.: ± (0.5 % *R* + 0.05 Ω)
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; 5 cycles	No visual damage **PR01**: Δ*R* max.: ± (1 % *R* + 0.05 Ω) **PR02**: Δ*R* max.: ± (1 % *R* + 0.05 Ω) **PR03**: Δ*R* max.: ± (2 % *R* + 0.05 Ω)
4.23		Climatic sequence:		
4.23.2	2 (Ba)	Dry heat	16 h; 155 °C	
4.23.3	30 (Db)	Damp heat (accelerated) 1st cycle	24 h; 55 °C; 90 % to 100 % RH	
4.23.4	1 (Aa)	Cold	2 h; - 55 °C	
4.23.5	13 (M)	Low air pressure	2 h; 8.5 kPa; 15 °C to 35 °C	
4.23.6	30 (Db)	Damp heat (accelerated) remaining cycles	5 days; 55 °C; 95 % to 100 % RH	R_{ins} min.: 10^3 MΩ Δ*R* max.: ± (1.5 % *R* + 0.1 Ω)
4.24	78 (Cab)	Damp heat (steady state)	56 days; 40 °C; 90 % to 95 % RH; loaded with 0.01 P_{70} (Steps: 0 V to 100 V)	R_{ins} min.: 1000 MΩ Δ*R* max.: ± (3 % *R* + 0.1 Ω)
4.25.1		Endurance (at 70 °C)	1000 h; loaded with P_{70} or $U_{max.}$; 1.5 h ON and 0.5 h OFF	Δ*R* max.: ± (5 % *R* + 0.1 Ω)
4.8		Temperature coefficient	Between - 55 °C and + 155 °C	≤ ± 250 ppm/K
4.6.1.1		Insulation resistance	Maximum voltage (DC) after 1 min; metal block method	R_{ins} min.: 10^4 MΩ

12NC INFORMATION FOR HISTORICAL CODING REFERENCE

The resistors have a 12-digit numeric code starting with 23

For 5 % tolerance:

- The next 7 digits indicate the resistor type and packing
- The remaining 3 digits indicate the resistance value:
  - The first 2 digits indicate the resistance value
  - The last digit indicates the resistance decade

For 1 % tolerance:

- The next 6 digits indicate the resistor type and packing
- The remaining 4 digits indicate the resistance value:
  - The first 3 digits indicate the resistance value
  - The last digit indicates the resistance decade

Last Digit of 12NC Indicating Resistance Decade

RESISTANCE DECADE	LAST DIGIT
0.22 to 0.91 Ω	7
1 to 9.76 Ω	8
10 to 97.6 Ω	9
100 to 976 Ω	1
1 to 9.76 kΩ	2
10 to 97.6 kΩ	3
100 to 976 kΩ	4
1 MΩ	5

12NC Example

The 12NC for resistor type PR02 with Cu leads and a value of 750 Ω with 5 % tolerance, supplied on a bandolier of 1000 units in ammopack, is: 2306 198 53751.

12NC - Resistor Type and Packaging (1)

TYPE	LEAD Ø mm	TOL (%)	23.. ... . (BANDOLIER)						
			AMMOPACK					REEL	
			RADIAL TAPED		STRAIGHT LEADS				RADIAL TAPED
					52 mm	52 mm	63 mm	52 mm	
			4000 units	3000 units	5000 units	1000 units	500 units	5000 units	2000 units
PR01	Cu 0.6	1	-	-	**22 196 1....**	06 191 2....	-	06 191 5....	-
		5	**06 197 03...**	-	**22 193 14...**	06 197 53...	-	**06 197 23...**	-
PR02	Cu 0.8	1	-	22 197 2....	-	**22 197 1....**	-	06 192 5....	**2322 197 5....**
		5	-	06 198 03...	-	**06 198 53...**	-	**06 198 23...**	**2322 198 04...**
	FeCu 0.6	5	-	-	-	22 194 54...	-	-	-
PR03	Cu 0.8	5	-	-	-	-	**22 195 14...**	-	-
		1	-	-	-	-	**06 199 6...**	-	-
	FeCu 0.6	5	-	-	-	-	**22 195 54...**	-	-

Notes

(1) Other packaging versions are available on request

- Preferred types in bold

12NC - Resistor Type and Packaging

TYPE	LEAD Ø mm	TOL (%)	23.. ... . (LOOSE IN BOX)			
			DOUBLE KINK			
			PITCH = 17.8 mm	PITCH = 25.4 mm	PITCH (2)(3)(4)	
			1000 units	500 units	1000 units	500 units
PR01	Cu 0.6	5	22 193 03...	-	-	-
	FeCu 0.6	5	22 193 43...	-	**22 193 53...** (2)	-
PR02	Cu 0.8	5	22 194 23...	-	-	-
	FeCu 0.6	5	22 194 83...	-	-	-
	FeCu 0.8	5	-	-	**22 194 63...** (3)	-
PR03	Cu 0.8	5	-	22 195 23...	-	-
	FeCu 0.6	5	-	22 195 83...	-	-
	FeCu 0.8	5	-	-	-	**22 195 63...** (4)

Notes

(2) PR01 pitch 12.5 mm

(3) PR02 pitch 15.0 mm

(4) PR03 pitch 20.0 mm, with reversed kinking direction as opposed to the drawing for the type with double kink figure

- Preferred types in bold

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